To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT2114R, HAT2114RJ

Silicon N Channel Power MOS FET
High Speed Power Switching

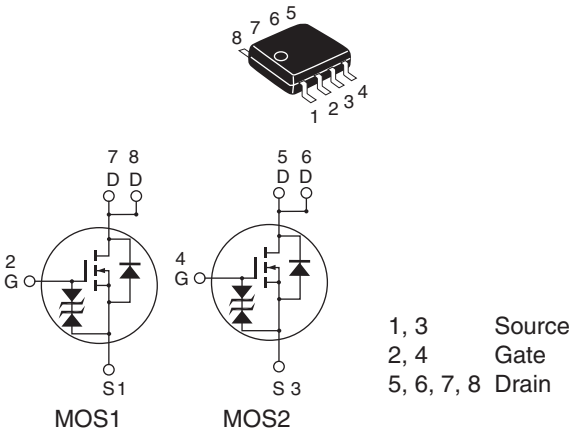
REJ03G0120-0100Z
(Previous ADE-208-1544(Z))
Rev.1.00
Oct.06.2003

Features

- Low on-resistance
- Capable of 4.5V gate drive
- High density mounting
- "J" is for Automotive application
  High temperature D-S leakage guarantee
  Avalanche rating

Outline

SOP-8



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings		Unit
		HAT2114R	HAT2114RJ	
Drain to source voltage	V_{DSS}	60	60	V
Gate to source voltage	V_{GSS}	±20	±20	V
Drain current	I_D	6	6	A
Drain peak current	I_D (pulse)[Note1]	48	48	A
Avalanche current	I_{AP}[Note4]	—	6	A
Avalanche energy	E_{AR}[Note4]	—	3.08	mJ
Channel dissipation	Pch[Note2]	2	2	W
Channel dissipation	Pch[Note3]	3	3	W
Channel temperature	Tch	150	150	°C
Storage temperature	Tstg	–55 to +150	–55 to +150	°C

Notes: 1. PW ≤ 10µs, duty cycle ≤ 1%
2. 1 Drive operation: When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW ≤ 10 s
3. 2 Drive operation: When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW ≤ 10 s
4. Value at Tch = 25°C, Rg ≥ 50 Ω

Electrical Characteristics

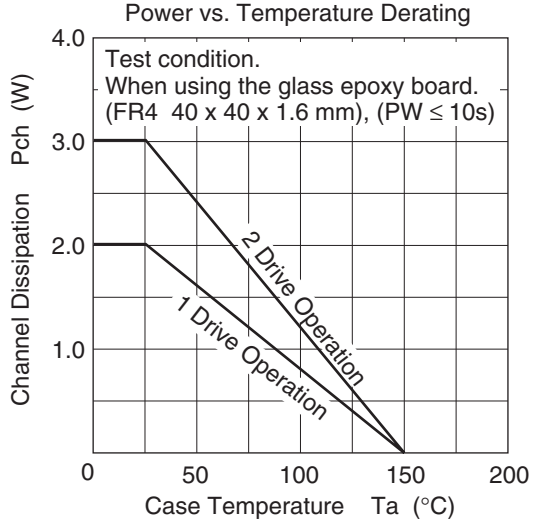
(Ta = 25°C)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage		$V_{(BR)DSS}$	60	—	—	V	I_D = 10 mA, V_{GS} = 0
Gate to Source breakdown voltage		$V_{(BR)GSS}$	±20	—	—	V	I_G = ±100 µA, V_{DS} = 0
Zero gate voltage drain current		I_{DSS}	—	—	1	µA	V_{DS} = 60 V, V_{GS} = 0
Zero gate voltage drain current	HAT2114R	I_{DSS}	—	—	—	µA	V_{DS} = 48 V, V_{GS} = 0
	HAT2114RJ	I_{DSS}	—	—	10	µA	Ta = 125°C
Gate to source leak current		I_{GSS}	—	—	±10	µA	V_{GS} = ±16 V, V_{DS} = 0
Gate to source cutoff voltage		$V_{GS(off)}$	1.5	—	2.5	V	V_{DS} = 10 V, I_D = 1 mA
Forward transfer admittance		$\|y_{fs}\|$	6	9.5	—	S	I_D = 3 A[Note5], V_{DS} = 10 V
Static drain to source on state resistance		$R_{DS(on)}$	—	28	32	mΩ	I_D = 3 A[Note5], V_{GS} = 10 V
		$R_{DS(on)}$	—	40	50	mΩ	I_D = 3 A[Note5], V_{GS} = 4.5 V
Input capacitance		Ciss	—	1000	—	pF	V_{DS} = 10V, V_{GS} = 0
Output capacitance		Coss	—	145	—	pF	f = 1 MHz
Reverse transfer capacitance		Crss	—	85	—	pF	
Total gate charge		Qg	—	15	—	nC	V_{DD} = 25 V
Gate to source charge		Qgs	—	2	—	nC	V_{GS} = 10 V
Gate to drain charge		Qgd	—	3	—	nC	I_D = 6A
Turn-on delay time		td(on)	—	12	—	ns	V_{GS} = 10 V, I_D= 3 A
Rise time		tr	—	10	—	ns	V_{DD} ≅ 30 V
Turn-off delay time		td(off)	—	60	—	ns	R_L = 10 Ω
Fall time		tf	—	11	—	ns	R_G =4.7 Ω
Body-drain diode forward voltage		V_{DF}	—	0.82	1.07	V	I_F = 6 A, V_{GS} = 0[Note5]
Body-drain diode reverse recovery time		trr	—	40	—	ns	I_F = 6A, V_{GS} = 0 diF/dt = 100 A/µs

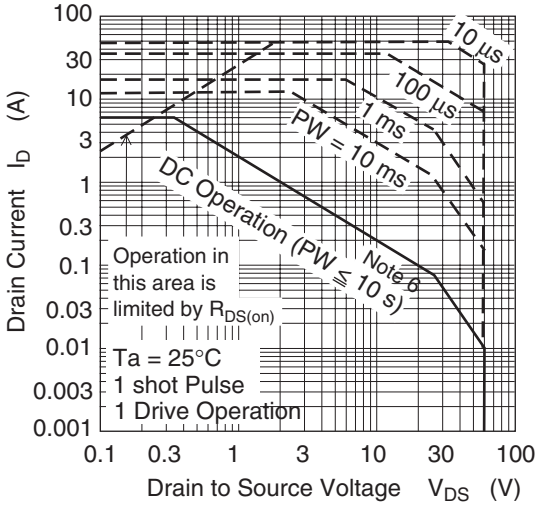
Notes: 5. Pulse test

Main Characteristics

Power vs. Temperature Derating

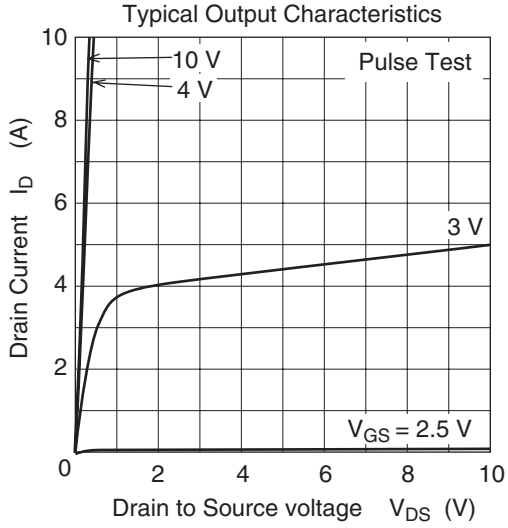


Maximum Safe Operation Area

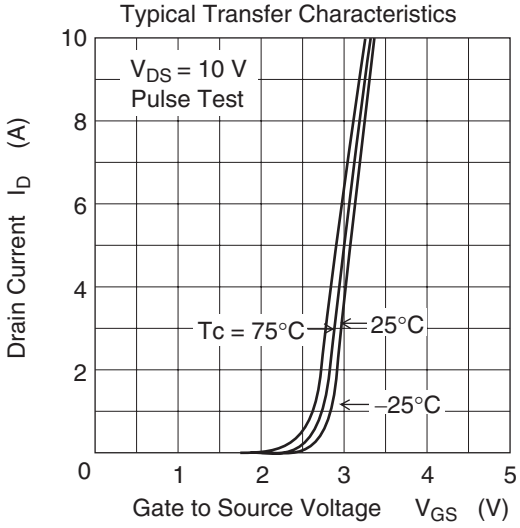


Note 6: When using the glass epoxy board (FR4 40 × 40 × 1.6 mm)

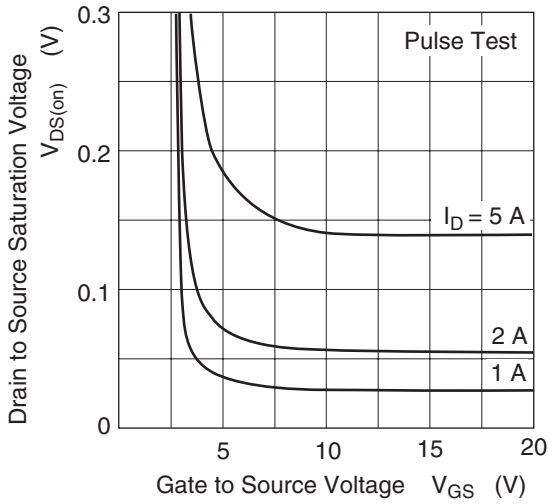
Typical Output Characteristics



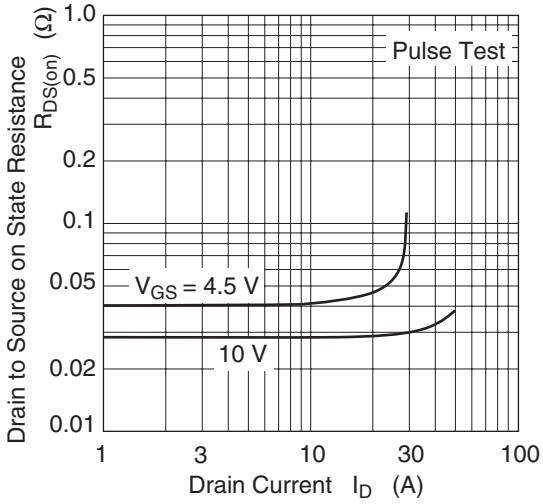
Typical Transfer Characteristics



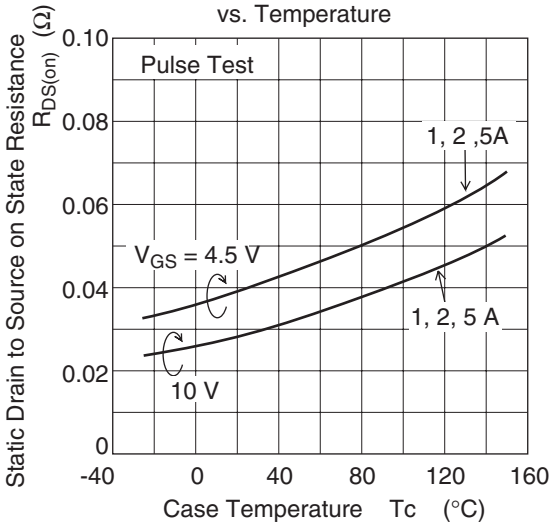
Drain to Source Saturation Voltage vs. Gate to Source Voltage



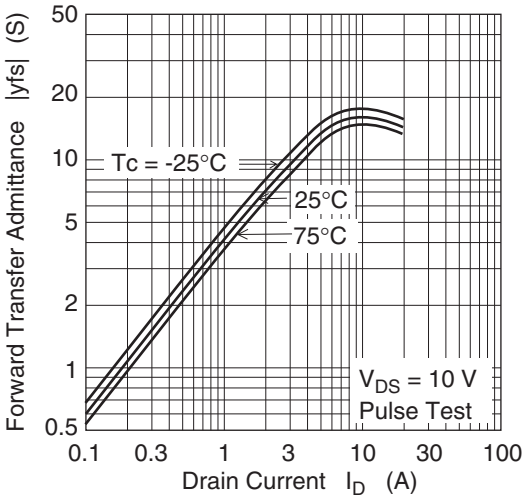
Static Drain to Source on State Resistance vs. Drain Current



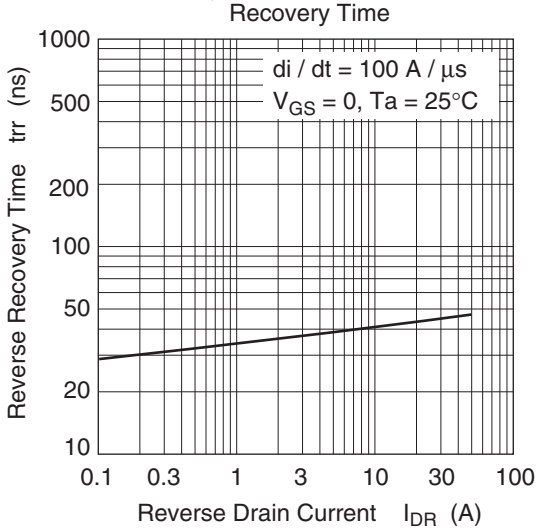
Static Drain to Source on State Resistance vs. Temperature



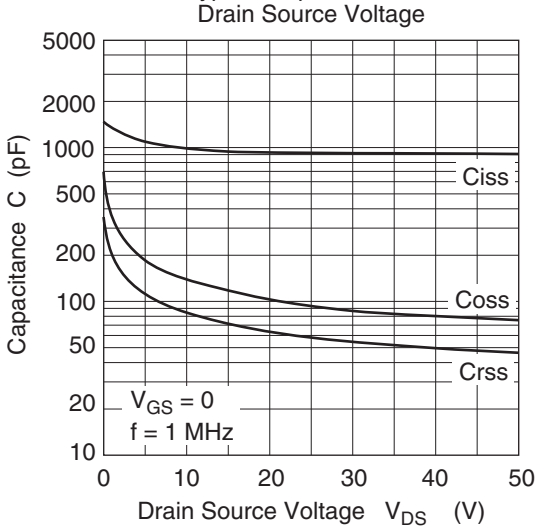
Forward Transfer Admittance vs. Drain Current



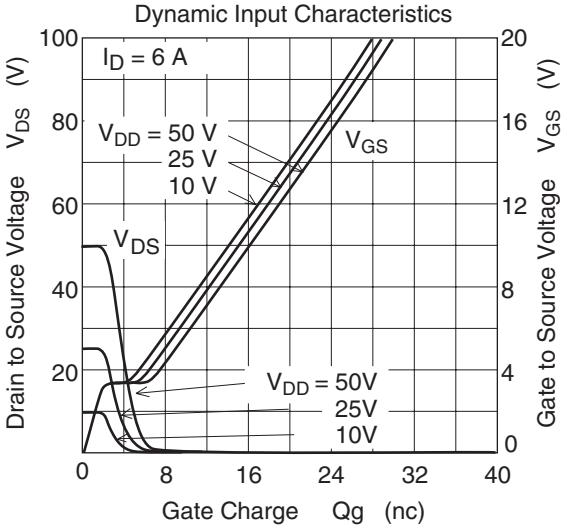
Body-Drain Diode Reverse Recovery Time



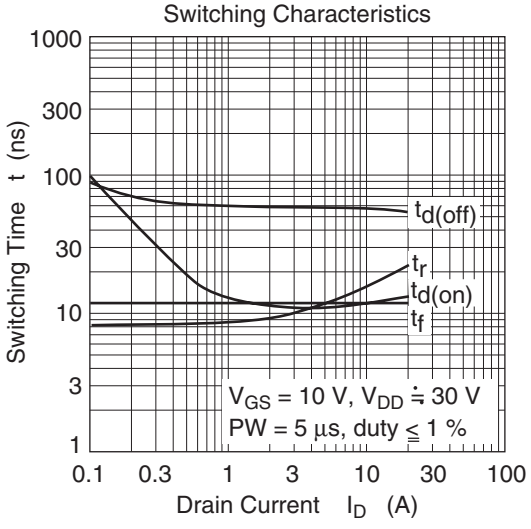
Typical Capacitance vs. Drain Source Voltage



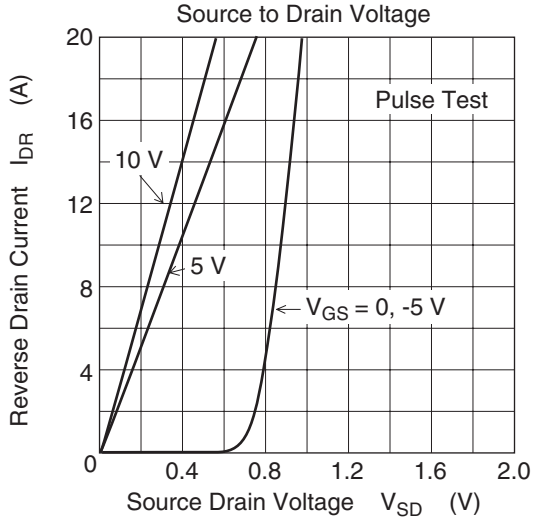
Dynamic Input Characteristics



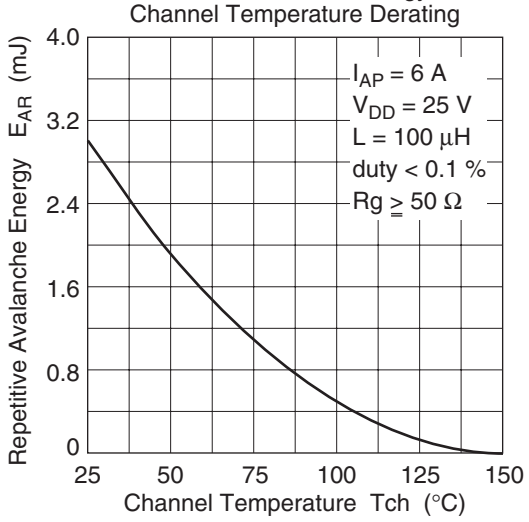
Switching Characteristics



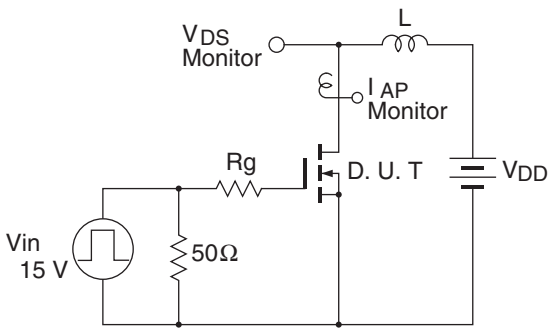
Reverse Drain Current vs. Source to Drain Voltage



Maximum Avalanche Energy vs. Channel Temperature Derating

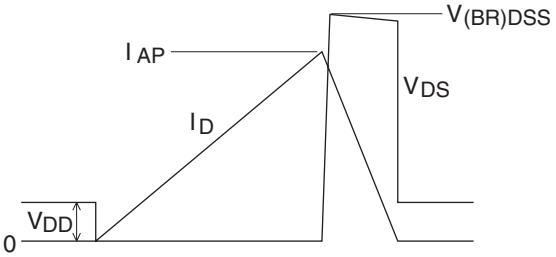


Avalanche Test Circuit

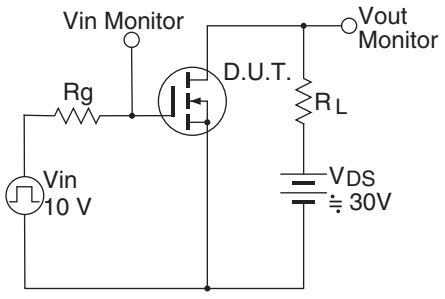


Avalanche Waveform

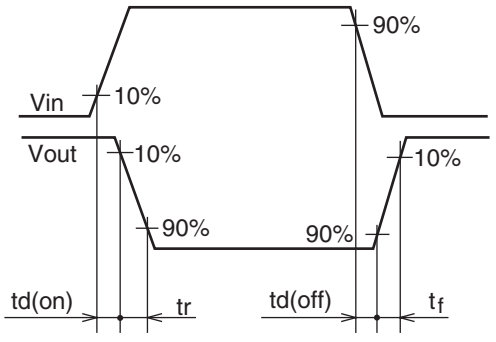
$$E_{AR} = \frac{1}{2} \bullet L \bullet I_{AP}^2 \bullet \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$



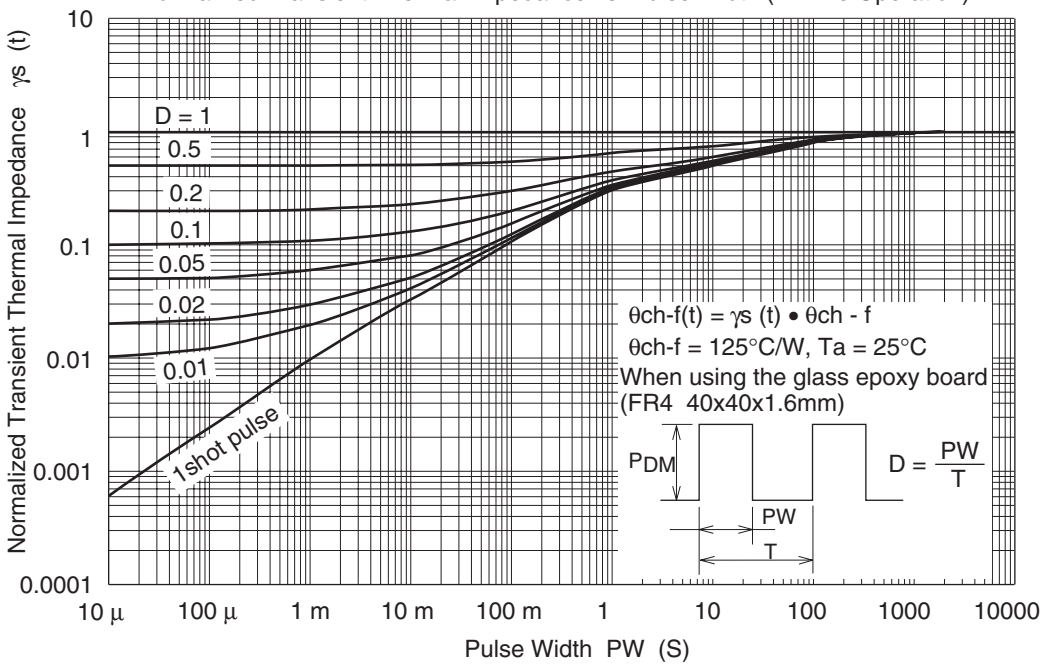
Switching Time Test Circuit



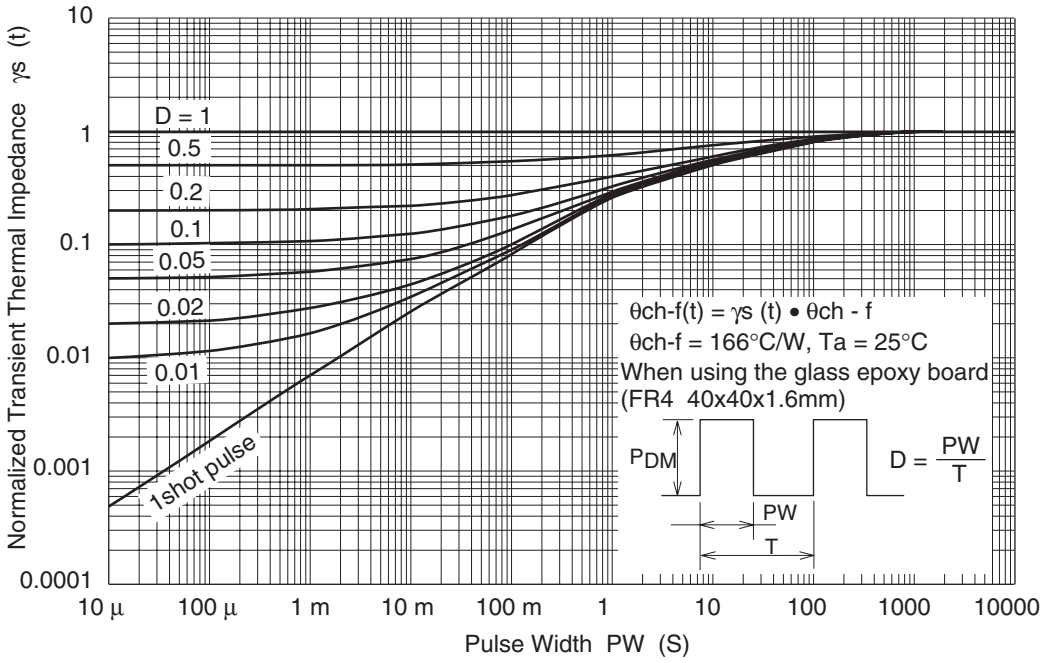
Switching Time Waveform



Normalized Transient Thermal Impedance vs. Pulse Width (1 Drive Operation)



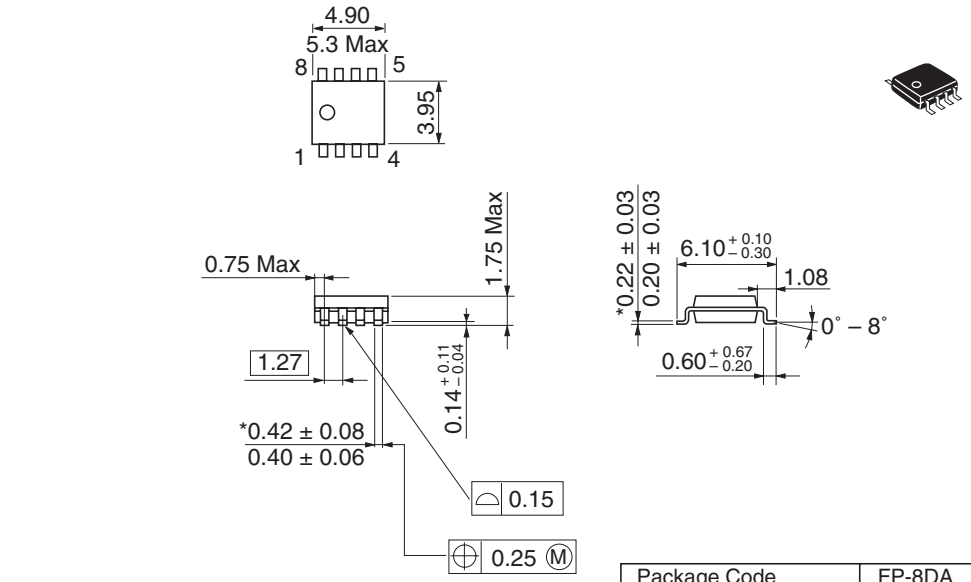
Normalized Transient Thermal Impedance vs. Pulse Width (2 Drive Operation)



Package Dimensions

As of January, 2003

Unit: mm



*Dimension including the plating thickness
Base material dimension

Package Code	FP-8DA
JEDEC	Conforms
JEITA	—
Mass (reference value)	0.085 g

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